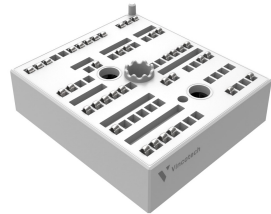
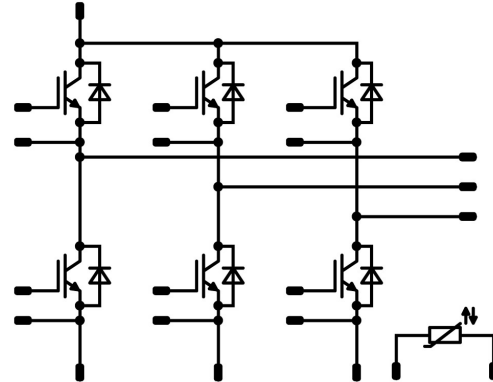




Vincotech

| MiniSKiiP PACK 2 | 1200 V / 50 A |
|---|--|
| <div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Features</p> <ul style="list-style-type: none"> Three-phase inverter </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Target applications</p> <ul style="list-style-type: none"> Embedded Drives Industrial Drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Types</p> <ul style="list-style-type: none"> V23990-K359-F40-PM </div> | <div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">MiniSKiiP 2 housing</p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #cccccc; margin: 0;">Schematic</p>  </div> |

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------------------------------|------------|--|-------|------|
| Inverter Switch | | | | |
| Collector-emitter voltage | V_{CES} | | 1200 | V |
| Collector current | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 60 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 150 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 163 | W |
| Gate-emitter voltage | V_{GES} | | ±20 | V |
| Short circuit ratings | t_{SC} | $V_{GE} = 15\text{ V}$ $V_{CE} = 800\text{ V}$ $T_j = 150\text{ °C}$ | 10 | µs |
| Maximum junction temperature | T_{jmax} | | 175 | °C |



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|--|-------------------|---|-------|------|
| Inverter Diode | | | | |
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V |
| Continuous (direct) forward current | I_F | $T_j = T_{j\text{max}}$ $T_s = 80\text{ °C}$ | 54 | A |
| Surge (non-repetitive) forward current | I_{FSM} | 50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$ | 270 | A |
| Total power dissipation | P_{tot} | $T_j = T_{j\text{max}}$ $T_s = 80\text{ °C}$ | 123 | W |
| Maximum junction temperature | $T_{j\text{max}}$ | | 175 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|------------------|--|---------------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{top} | | -40...($T_{j\text{max}}$ - 25) | °C |

Isolation Properties

| | | | | |
|----------------------------|-------------------|--|-------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 5500 | V |
| | | AC Voltage $t_p = 1\text{ min}$ | 2500 | V |
| Creepage distance | | With std lid For more informations see handling in- structions | 6,3 | mm |
| Clearance | | With std lid For more informations see handling in- structions | 6,3 | mm |
| Comparative Tracking Index | CTI | | > 200 | |

*100 % tested in production



Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|-------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Inverter Switch

Static

| | | | | | | | | | | |
|--------------------------------------|--------------|-------------------|----|------|--------|-----------|------|--------------|-----|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{GE} = V_{CE}$ | | | 0,0017 | 25 | 5,3 | 5,8 | 6,3 | V |
| Collector-emitter saturation voltage | V_{CEsat} | | 15 | | 50 | 25 150 | 1,58 | 1,92 2,33 | 2,2 | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 1200 | | 25 | | | 61 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | 4 | | Ω |
| Input capacitance | C_{ies} | $f = 1$ Mhz | 0 | 25 | | 25 | | 2800 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 100 | | |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | $\lambda_{paste} = 2,5$ W/mK (HPTP) | | | | | | 0,58 | | K/W |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|-------------------------------------|-----|-----|----|------|--|------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 8$ Ω $R_{goff} = 8$ Ω | ±15 | 600 | 50 | 25 | | 101 | | ns |
| Rise time | t_r | | | | | 150 | | 106 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 | | 19 | | |
| Fall time | t_f | | | | | 150 | | 25 | | |
| Turn-on energy (per pulse) | E_{on} | | | | | 25 | | 224 | | |
| Turn-off energy (per pulse) | E_{off} | 150 | | 296 | | | | | | |
| | | | | 25 | | 89 | | 116 | | |
| | | | | 25 | | 2,64 | | 4,62 | | mWs |
| | | | | 150 | | 2,89 | | 4,75 | | |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|-------|-----|-----|------|
| | | V_{GS} [V] | V_{GE} [V] | V_{DS} [V] | I_D [A] | T_j [°C] | Min | Typ | Max | |

Inverter Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|--|--|------|----|-----------|--|--------------|------------|---------|
| Forward voltage | V_F | | | | 50 | 25 150 | | 2,20 2,20 | 2,6 | V |
| Reverse leakage current | I_R | | | 1200 | | 25 150 | | | 60 8800 | μ A |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|-------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | $\lambda_{paste} = 2,5$ W/mK (HPTP) | | | | | | 0,77 | | K/W |
|-------------------------------------|---------------|-------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|--|----------|-----|----|-----------|--|--------------|--|------------|
| Peak recovery current | I_{RRM} | $di/dt = 3197$ A/ μ s $di/dt = 2339$ A/ μ s | ± 15 | 600 | 50 | 25 150 | | 53,6 67 | | A |
| Reverse recovery time | t_{rr} | | | | | 25 150 | | 121 294 | | ns |
| Recovered charge | Q_r | | | | | 25 150 | | 3,25 8,66 | | μ C |
| Reverse recovered energy | E_{rec} | | | | | 25 150 | | 1,12 3,35 | | mWs |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | | | | 25 150 | | 2708 467 | | A/ μ s |

Thermistor

| | | | | | | | | | | |
|----------------------------|----------------|---------------------------|--|--|--|-----|----|-----------------------|----|------------------|
| Rated resistance | R | | | | | 25 | | 1 | | k Ω |
| Deviation of R_{100} | $\Delta_{R/R}$ | $R_{100} = 1670$ Ω | | | | 100 | -2 | | +2 | % |
| R_{100} | R | | | | | 100 | | 1670 | | Ω |
| Power dissipation constant | | | | | | 25 | | 0,76 | | mW/K |
| A-value | $A_{(25/50)}$ | | | | | 25 | | $7,635 \cdot 10^{-3}$ | | 1/K |
| B-value | $B_{(25/100)}$ | | | | | 25 | | $1,731 \cdot 10^{-5}$ | | 1/K ² |
| Vincotech PTC Reference | | | | | | | | | E | |

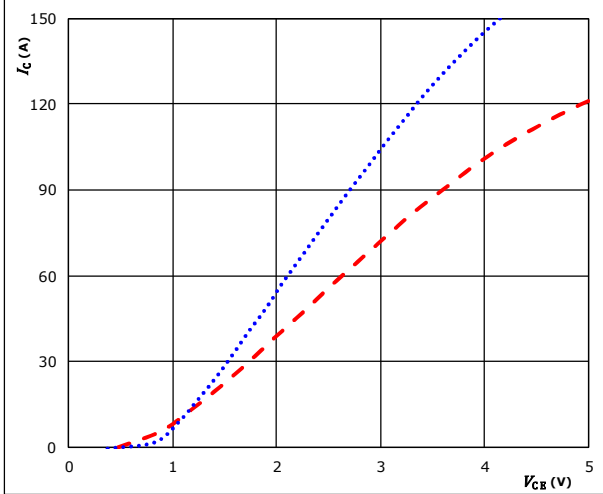


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

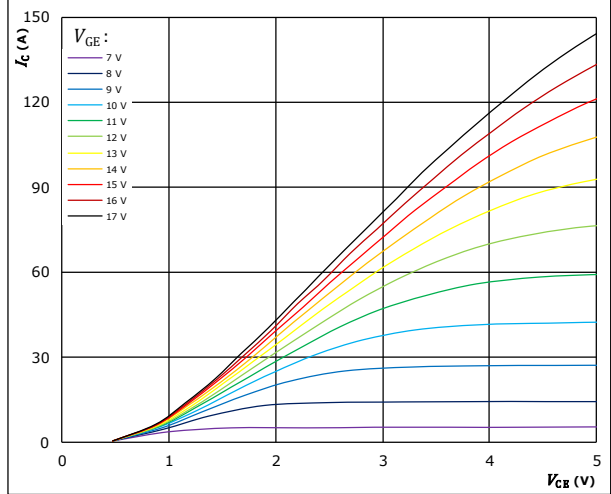


$t_p = 250 \mu\text{s}$
 $V_{GE} = 15 \text{ V}$
 $T_j: 25 \text{ }^\circ\text{C}$ (blue dotted line)
 $150 \text{ }^\circ\text{C}$ (red dashed line)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

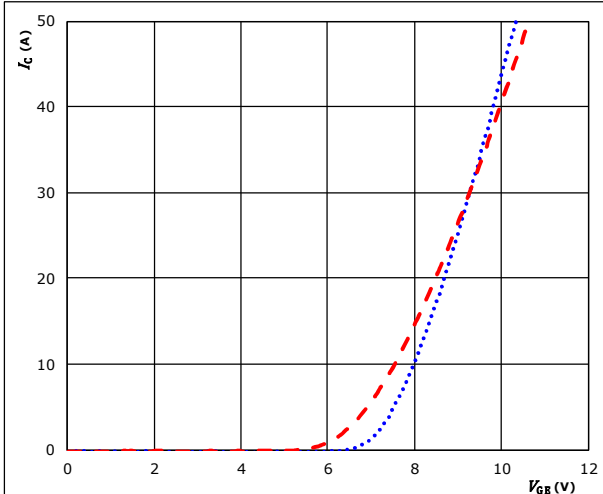


$t_p = 250 \mu\text{s}$
 $T_j = 150 \text{ }^\circ\text{C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

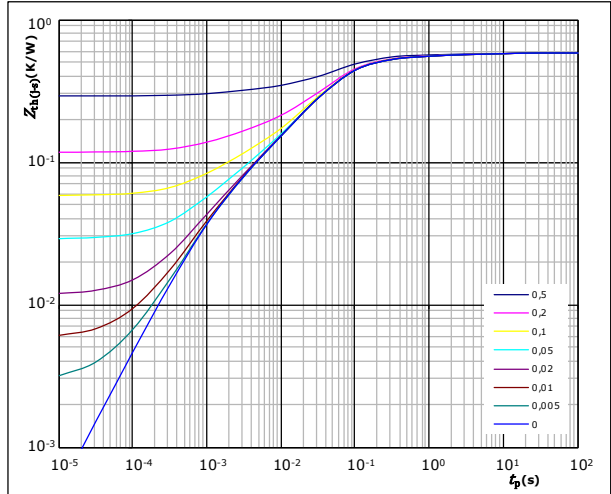


$t_p = 100 \mu\text{s}$
 $V_{CE} = 10 \text{ V}$
 $T_j: 25 \text{ }^\circ\text{C}$ (blue dotted line)
 $150 \text{ }^\circ\text{C}$ (red dashed line)

figure 4. IGBT

Transient thermal impedance as function of pulse duration

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,58 \text{ K/W}$

IGBT thermal model values

| R (K/W) | τ (s) |
|-----------|------------|
| 2,17E-02 | 4,34E+00 |
| 4,06E-02 | 3,69E-01 |
| 1,08E-01 | 6,60E-02 |
| 3,12E-01 | 2,21E-02 |
| 5,81E-02 | 4,29E-03 |
| 3,90E-02 | 6,58E-04 |
| 2,69E-03 | 3,18E-04 |



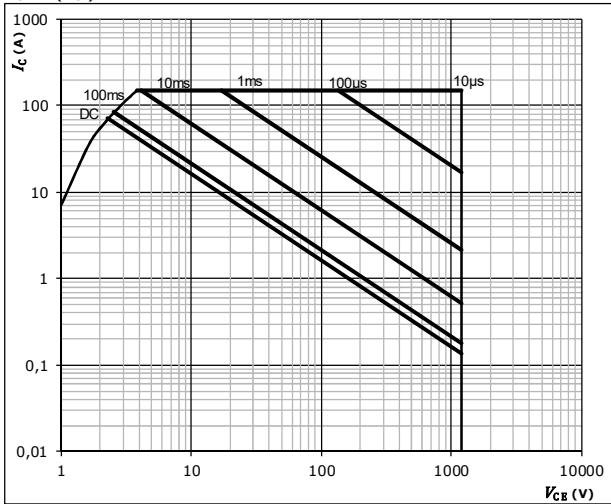
Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = \pm 15$ V
 $T_j = T_{jmax}$

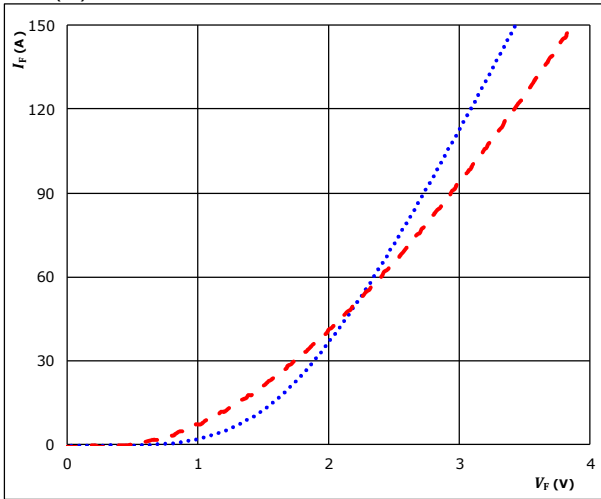


Inverter Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

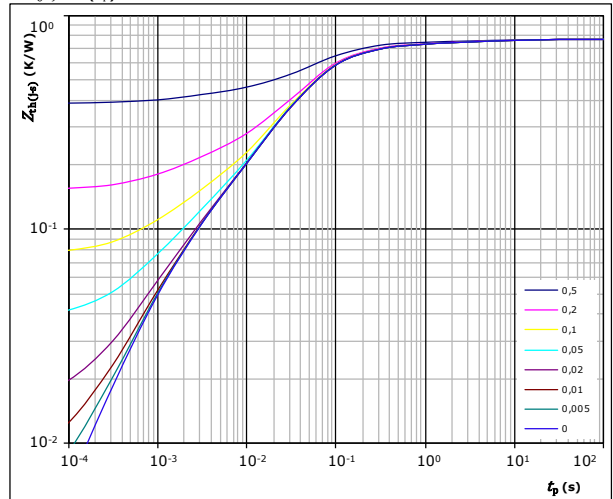


$t_p = 250 \mu s$
 $T_j: 25 \text{ }^\circ\text{C}$ (dotted blue line)
 $150 \text{ }^\circ\text{C}$ (dashed red line)

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,77 \text{ K/W}$

FWD thermal model values

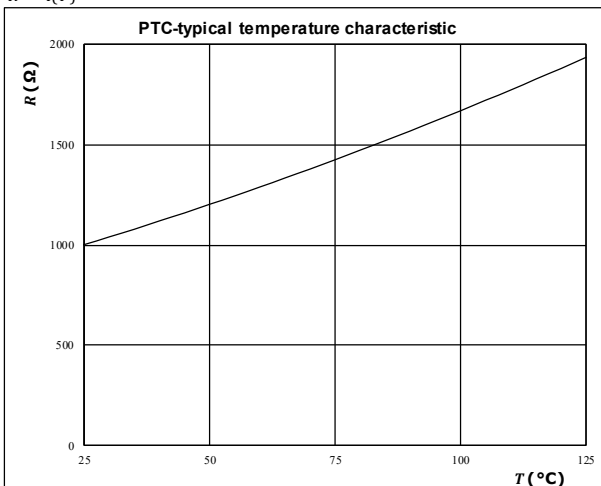
| $R \text{ (K/W)}$ | $\tau \text{ (s)}$ |
|-------------------|--------------------|
| 2,87E-02 | 5,74E+00 |
| 5,37E-02 | 4,89E-01 |
| 1,43E-01 | 8,73E-02 |
| 4,13E-01 | 2,92E-02 |
| 7,69E-02 | 5,67E-03 |
| 5,16E-02 | 8,71E-04 |
| 3,56E-03 | 4,21E-04 |

Thermistor Characteristics

figure 1. Thermistor

Typical PTC characteristic
as a function of temperature

$$R = f(T)$$



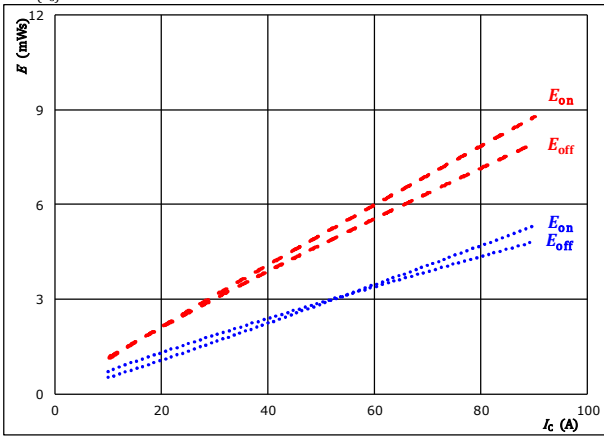


Inverter Switching Characteristics

figure 1. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

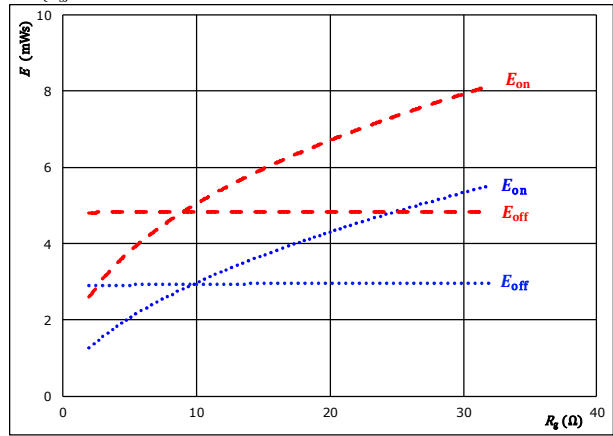
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

T_j : 25 °C (blue dotted)
150 °C (red dashed)

figure 2. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

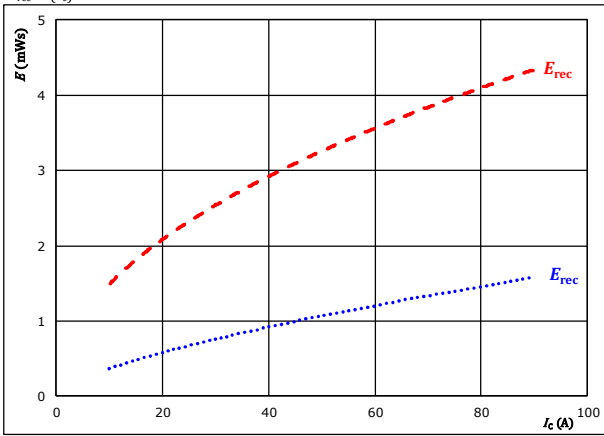
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

T_j : 25 °C (blue dotted)
150 °C (red dashed)

figure 3. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

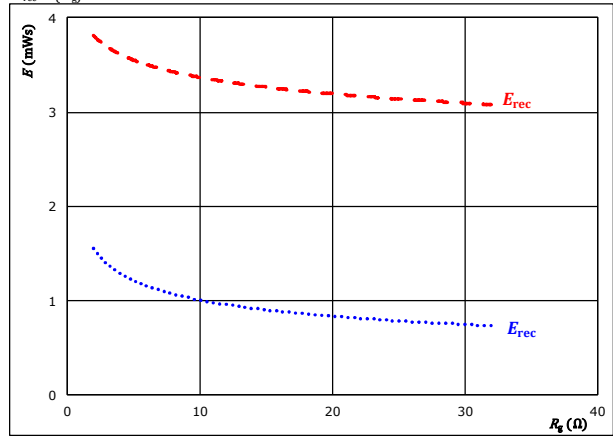
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j : 25 °C (blue dotted)
150 °C (red dashed)

figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

T_j : 25 °C (blue dotted)
150 °C (red dashed)

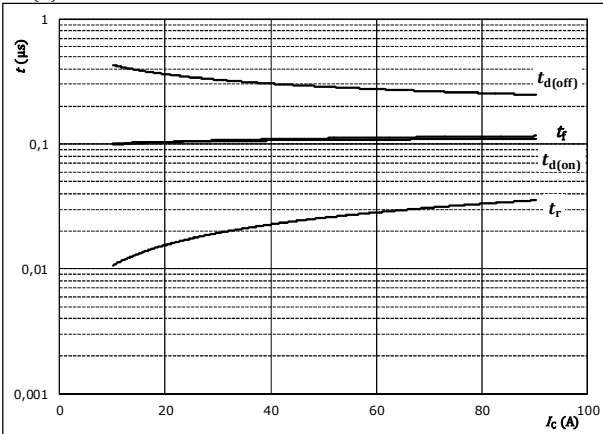


Inverter Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



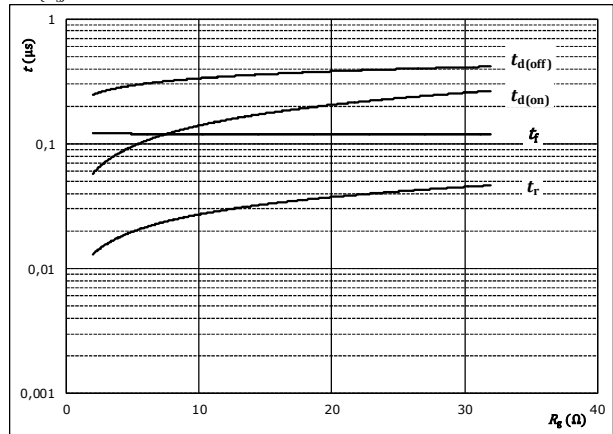
With an inductive load at

| | | |
|----------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{g(on)} =$ | 8 | Ω |
| $R_{g(off)} =$ | 8 | Ω |

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



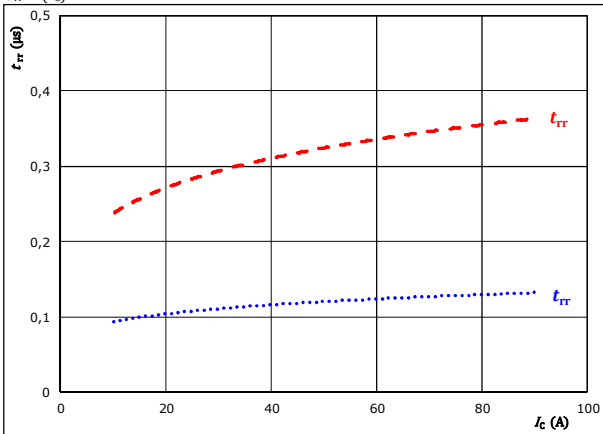
With an inductive load at

| | | |
|------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 50 | A |

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

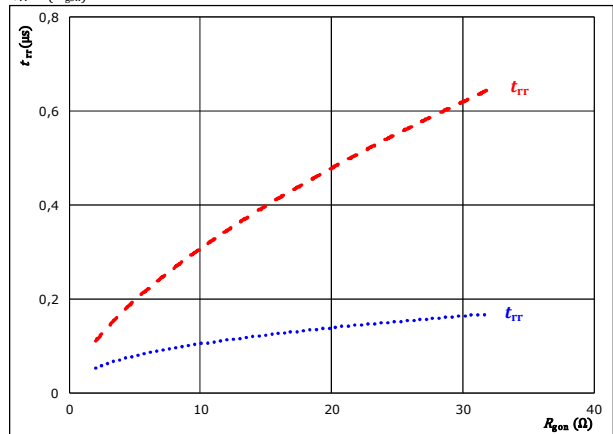
| | | |
|---------------|-----|---|
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{g(on)} =$ | 8 | Ω |

$T_j:$ 25 °C (blue dotted line)
150 °C (red dashed line)

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



With an inductive load at

| | | |
|------------|-----|---|
| $V_{CE} =$ | 600 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 50 | A |

$T_j:$ 25 °C (blue dotted line)
150 °C (red dashed line)

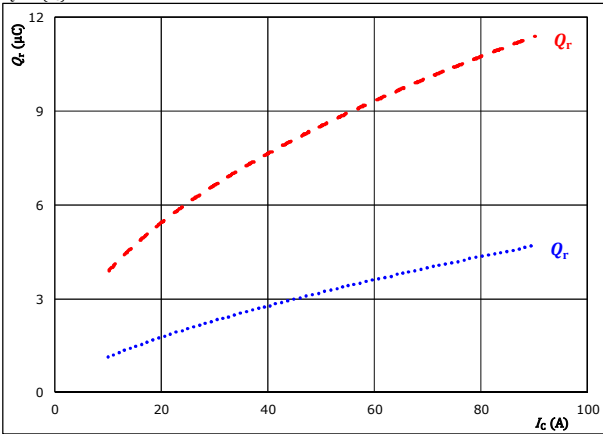


Inverter Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

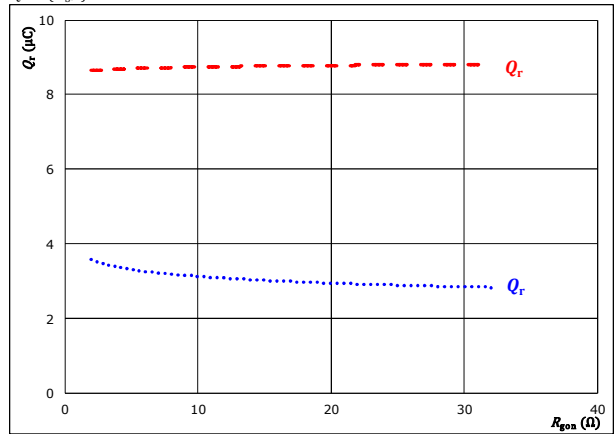


With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{ggn} = 8$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{ggn})$$

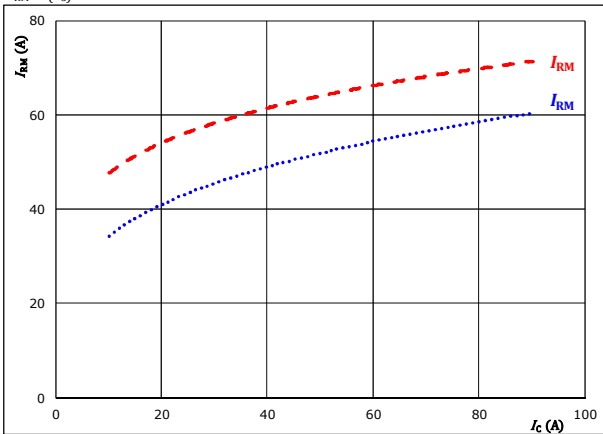


With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

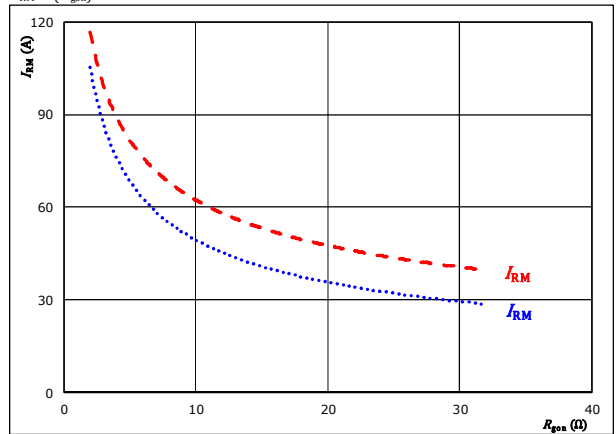


With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{ggn} = 8$ Ω
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)

figure 12. FWD

Typical peak reverse recovery current current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{ggn})$$



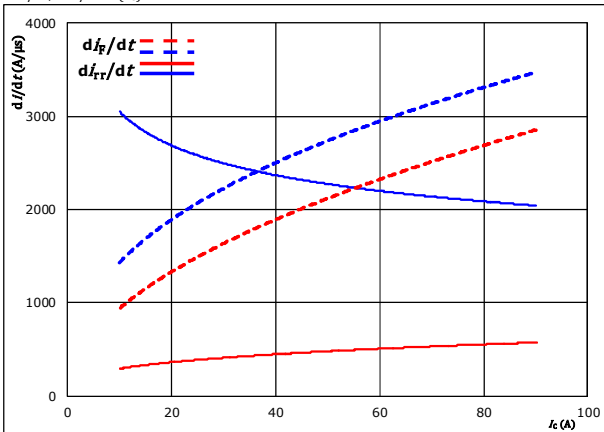
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A
 $T_j: 25$ °C (blue dotted line)
 150 °C (red dashed line)



Inverter Switching Characteristics

figure 13. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



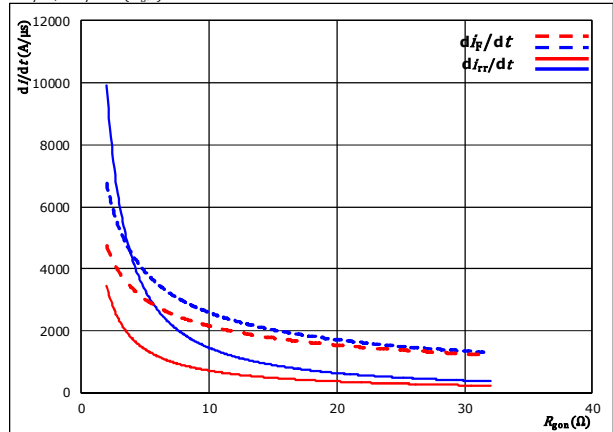
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 8$ Ω

$T_j:$ 25 °C
 150 °C

figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_{g\text{on}})$



With an inductive load at

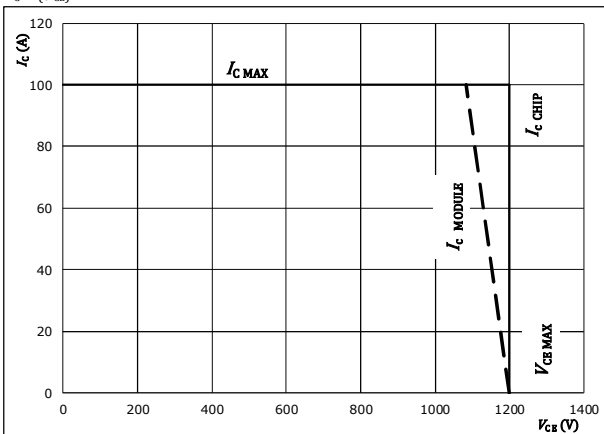
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

$T_j:$ 25 °C
 150 °C

figure 15. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

$T_j = 150$ °C
 $R_{g\text{on}} = 8$ Ω
 $R_{g\text{off}} = 8$ Ω



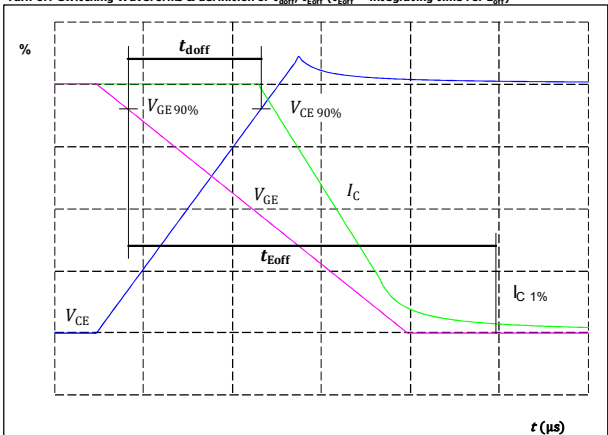
Inverter Switching Definitions

General conditions

| | | |
|------------|---|------------|
| T_j | = | 125 °C |
| R_{gon} | = | 8 Ω |
| R_{goff} | = | 8 Ω |

figure 1. IGBT

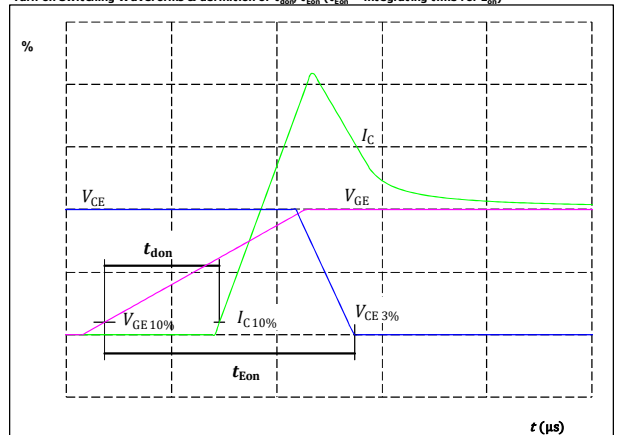
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



| | | |
|-------------------|-----|----|
| $V_{GE}(0\%) =$ | -15 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 50 | A |
| $t_{doff} =$ | 296 | ns |

figure 2. IGBT

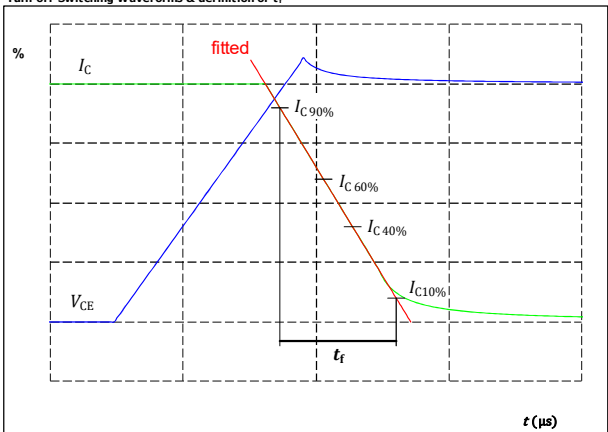
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



| | | |
|-------------------|-----|----|
| $V_{GE}(0\%) =$ | -15 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 50 | A |
| $t_{don} =$ | 106 | ns |

figure 3. IGBT

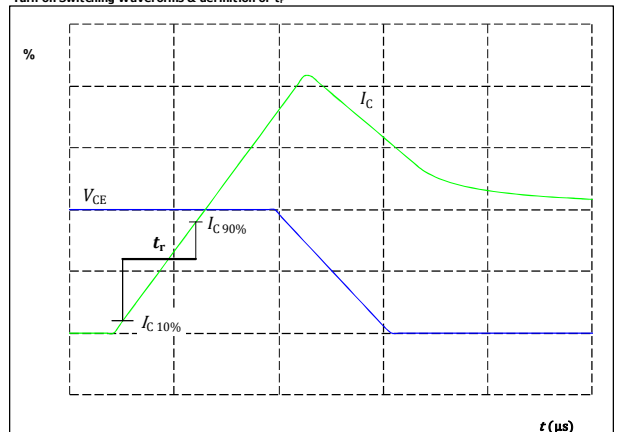
Turn-off Switching Waveforms & definition of t_r



| | | |
|----------------|-----|----|
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 50 | A |
| $t_r =$ | 116 | ns |

figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

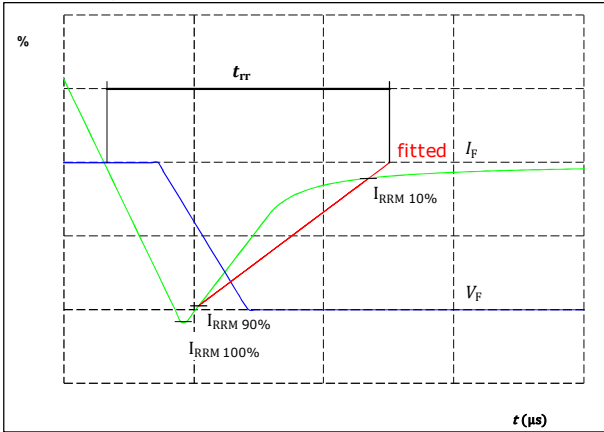


| | | |
|----------------|-----|----|
| $V_C(100\%) =$ | 600 | V |
| $I_C(100\%) =$ | 50 | A |
| $t_r =$ | 25 | ns |



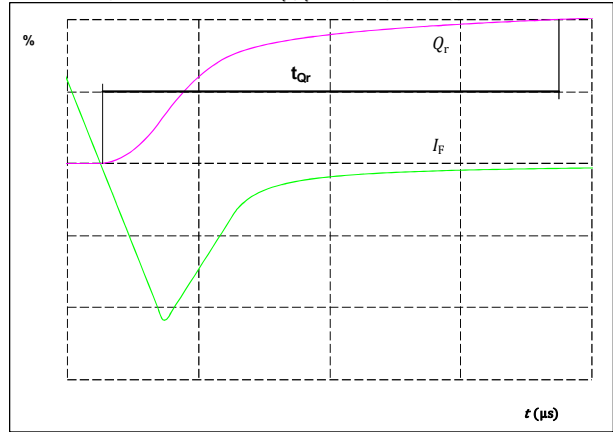
Inverter Switching Characteristics

figure 5. FWD
Turn-off Switching Waveforms & definition of t_{rr}



| | | |
|--------------------|-----|----|
| $V_F(100\%) =$ | 600 | V |
| $I_F(100\%) =$ | 50 | A |
| $I_{RRM}(100\%) =$ | 67 | A |
| $t_{rr} =$ | 294 | ns |

figure 6. FWD
Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



| | | |
|----------------|------|---------------|
| $I_F(100\%) =$ | 50 | A |
| $Q_r(100\%) =$ | 8,66 | μC |



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| Ordering Code & Marking | | | | | | | | | |
|--|--|--|------------|--------------------------|------------|----------|-----------|-------|--------|
| Version | | | | Ordering Code | | | | | |
| With std lid (6.5mm height) + no thermal grease | | | | V23990-K359-F40-/0A/ -PM | | | | | |
| With thin lid (2.8mm height) + no thermal grease | | | | V23990-K359-F40-/0B/ -PM | | | | | |
| With std lid (6.5mm height) + thermal grease (0,8 W/mK, P12, silicone-based) | | | | V23990-K359-F40-/1A/ -PM | | | | | |
| With thin lid (2.8mm height) + thermal grease (0,8 W/mK, P12, silicone-based) | | | | V23990-K359-F40-/1B/ -PM | | | | | |
| With std lid (6.5mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free) | | | | V23990-K359-F40-/4A/ -PM | | | | | |
| With thin lid (2.8mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free) | | | | V23990-K359-F40-/4B/ -PM | | | | | |
| With std lid (6.5mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based) | | | | V23990-K359-F40-/5A/ -PM | | | | | |
| With thin lid (2.8mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based) | | | | V23990-K359-F40-/5B/ -PM | | | | | |
| | | | Text | VIN | Date code | Name&Ver | UL | Lot | Serial |
| | | | | VIN | WWYY | NNNNNNVV | UL | LLLLL | SSSS |
| | | | | Type&Ver | Lot number | Serial | Date code | | |
| | | | Datamatrix | TTTTTTVV | LLLLL | SSSS | WWYY | | |

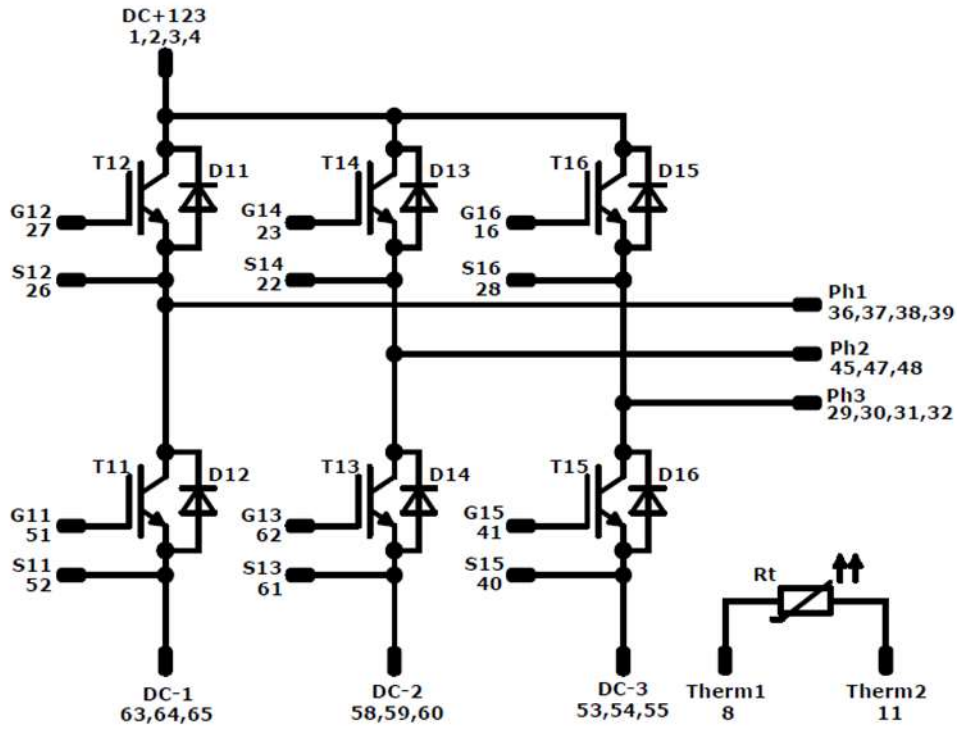
| Outline | | | | | | | |
|---------------|---------------|-------|----------|---------------|---------------|-------|----------|
| PCB pad table | | | | PCB pad table | | | |
| Pin | X | Y | Function | Pin | X | Y | Function |
| 1 | 24,38 | -21,8 | DC+123 | 48 | -12,22 | 7,1 | Ph2 |
| 2 | 24,38 | -18,6 | DC+123 | 49 | Not assembled | | |
| 3 | 24,38 | -15,4 | DC+123 | 50 | Not assembled | | |
| 4 | 24,38 | -12,2 | DC+123 | 51 | -12,22 | 18,6 | G11 |
| 5 | Not assembled | | | 52 | -12,22 | 21,8 | S11 |
| 6 | Not assembled | | | 53 | -24,38 | -21,8 | DC-3 |
| 7 | Not assembled | | | 54 | -24,38 | -18,6 | DC-3 |
| 8 | 24,38 | 12,2 | Therm1 | 55 | -24,38 | -15,4 | DC-3 |
| 9 | Not assembled | | | 56 | Not assembled | | |
| 10 | Not assembled | | | 57 | Not assembled | | |
| 11 | 24,38 | 21,8 | Therm2 | 58 | -24,38 | -5,8 | DC-2 |
| 12 | Not assembled | | | 59 | -24,38 | -2,5 | DC-2 |
| 13 | Not assembled | | | 60 | -24,38 | 0,7 | DC-2 |
| 14 | Not assembled | | | 61 | -24,38 | 3,9 | S13 |
| 15 | Not assembled | | | 62 | -24,38 | 7,1 | G13 |
| 16 | 13,42 | -21,8 | G16 | 63 | -24,38 | 15,4 | DC-1 |
| 17 | Not assembled | | | 64 | -24,38 | 18,6 | DC-1 |
| 18 | Not assembled | | | 65 | -24,38 | 21,8 | DC-1 |
| 19 | Not assembled | | | | | | |
| 20 | Not assembled | | | | | | |
| 21 | Not assembled | | | | | | |
| 22 | 8,38 | 2,6 | S14 | | | | |
| 23 | 8,38 | 5,8 | G14 | | | | |
| 24 | Not assembled | | | | | | |
| 25 | Not assembled | | | | | | |
| 26 | 8,38 | 18,6 | S12 | | | | |
| 27 | 8,38 | 21,8 | G12 | | | | |
| 28 | 2,38 | -21,8 | S16 | | | | |
| 29 | 2,46 | -18,6 | Ph3 | | | | |
| 30 | 2,46 | -15,4 | Ph3 | | | | |
| 31 | 2,46 | -12,2 | Ph3 | | | | |
| 32 | 2,46 | -9 | Ph3 | | | | |
| 33 | Not assembled | | | | | | |
| 34 | Not assembled | | | | | | |
| 35 | Not assembled | | | | | | |
| 36 | 0,03 | 12,2 | Ph1 | | | | |
| 37 | 0,03 | 15,4 | Ph1 | | | | |
| 38 | 0,03 | 18,6 | Ph1 | | | | |
| 39 | 0,03 | 21,8 | Ph1 | | | | |
| 40 | -8,5 | -21,8 | S15 | | | | |
| 41 | -8,5 | -18,6 | G15 | | | | |
| 42 | Not assembled | | | | | | |
| 43 | Not assembled | | | | | | |
| 44 | Not assembled | | | | | | |
| 45 | -12,22 | -5,8 | Ph2 | | | | |
| 46 | Not assembled | | | | | | |
| 47 | -12,22 | 3,9 | Ph2 | | | | |

Pad positions refers to center point. For more informations on pad design please see package data



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Pinout



Identification

| ID | Component | Voltage | Current | Function | Comment |
|------------------------------|-----------|---------|---------|-----------------|---------|
| T11, T12, T13, T14, T15, T16 | IGBT | 1200 V | 50 A | Inverter Switch | |
| D11, D12, D13, D14, D15, D16 | FWD | 1200 V | 50 A | Inverter Diode | |
| Rt | PTC | | | Thermistor | |




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| Packaging instruction | | | |
|--------------------------------------|------|----------|-------------|
| Standard packaging quantity (SPQ) 72 | >SPQ | Standard | <SPQ Sample |

| Handling instruction |
|--|
| Handling instructions for MiniSkiiP® 2 packages see vincotech.com website. |

| Package data |
|---|
| Package data for MiniSkiiP® 2 packages see vincotech.com website. |

| UL recognition and file number |
|---|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.: | Date: | Modification: | Pages |
|-----------------------|--------------|--------------------------------|-------|
| V23990-K359-F40-D3-14 | 01 Mar. 2019 | Correction of I_c/I_f values | 1,2 |

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